

# SM6F23NSF/SM6F23NSFP/ SM6F23NSU/SM6F23NSUB



## N-Channel Enhancement Mode MOSFET

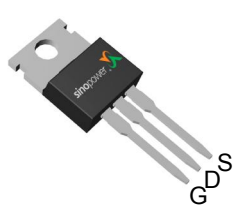
### Features

- 650V/6A,  
 $R_{DS(ON)} = 0.89\Omega(\text{max.}) @ V_{GS} = 10V$   
 $V_{DS} @ T_j, \text{max} = 750V (\text{typ.})$
- 100% UIS +  $R_g$  Tested
- Reliable and Rugged
- Avalanche Rated
- Lead Free and Green Devices Available  
 (RoHS Compliant)

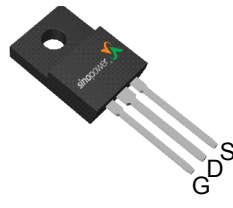
### Applications

- AC/DC Power Conversion in Switched Mode Power Supplies (SMPS).
- Uninterruptible Power Supply (UPS),
- Adapter.

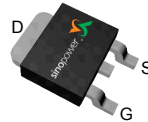
### Pin Description



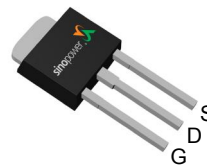
TO-220



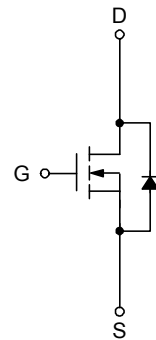
TO-220FP



TO-252-2



TO-251



N-Channel MOSFET

### Ordering and Marking Information

<p>SM6F23NS <span style="border: 1px solid black; padding: 2px;">□□□-□□□</span></p> <p style="margin-left: 40px;"> <span style="border-left: 1px solid black; border-right: 1px solid black; width: 10px; height: 10px; display: inline-block;"></span> Assembly Material  <span style="border-left: 1px solid black; border-right: 1px solid black; width: 10px; height: 10px; display: inline-block;"></span> Handling Code  <span style="border-left: 1px solid black; border-right: 1px solid black; width: 10px; height: 10px; display: inline-block;"></span> Temperature Range  <span style="border-left: 1px solid black; border-right: 1px solid black; width: 10px; height: 10px; display: inline-block;"></span> Package Code         </p>	<p>Package Code              F : TO-220 / FP : TO-220FP / U : TO-252-2 / UB : TO-251              Operating Junction Temperature Range              C : -55 to 150 °C              Handling Code              TU : Tube (TO-220 / TO-220FP / TO-251)              TR : Tape &amp; Reel (TO-252-2)              Assembly Material              G : Halogen and Lead Free Device</p>
<p>SM6F23NS F/FP/U/UB : <span style="border: 1px solid black; padding: 2px;">SM6F23NS XXXXX</span></p>	<p>XXXXX - Lot Code</p>

Note: SINOPOWER lead-free products contain molding compounds/die attach materials and 100% matte tin plate termination finish; which are fully compliant with RoHS. SINOPOWER lead-free products meet or exceed the lead-free requirements of IPC/JEDEC J-STD-020D for MSL classification at lead-free peak reflow temperature. SINOPOWER defines "Green" to mean lead-free (RoHS compliant) and halogen free (Br or Cl does not exceed 900ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500ppm by weight).

SINOPOWER reserves the right to make changes to improve reliability or manufacturability without notice, and advise customers to obtain the latest version of relevant information to verify before placing orders.

**Absolute Maximum Ratings** ( $T_A = 25^\circ\text{C}$  Unless Otherwise Noted)

Symbol	Parameter	Rating	Unit
<b>Common Ratings</b>			
$V_{DSS}$	Drain-Source Voltage	650	V
$V_{GSS}$	Gate-Source Voltage	$\pm 30$	
$T_J$	Maximum Junction Temperature	150	$^\circ\text{C}$
$T_{STG}$	Storage Temperature Range	-55 to 150	
$I_S$	Diode Continuous Forward Current	6 <sup>a</sup>	A
$I_{DP}$	Pulse Drain Current Tested	$T_C=25^\circ\text{C}$ 15 <sup>b</sup>	
$I_D$	Continuous Drain Current	$T_C=25^\circ\text{C}$ 6 <sup>a</sup>	
		$T_C=100^\circ\text{C}$ 3.8 <sup>a</sup>	
$P_D$	Maximum Power Dissipation for TO-220/TO-252-2/TO-251	$T_C=25^\circ\text{C}$ 86	W
		$T_C=100^\circ\text{C}$ 34.4	
$P_D$	Maximum Power Dissipation for TO-220FP	$T_C=25^\circ\text{C}$ 27	
		$T_C=100^\circ\text{C}$ 10.8	
$R_{\theta JC}$	Thermal Resistance-Junction to Case for TO-220/TO-252-2/TO-251	1.45	$^\circ\text{C/W}$
$R_{\theta JC}$	Thermal Resistance-Junction to Case for TO-220FP	4.6	
$R_{\theta JA}$	Thermal Resistance-Junction to Ambient	62.5	
<b>Drain-Source Avalanche Ratings</b>			
$dv/dt^c$	MOSFET $dv/dt$ ruggedness	50	V/ns
$E_{AS}^d$	Avalanche Energy, Single Pulsed	52.6	mJ
$I_{AR}^e$	Avalanche Current	0.9	A
$E_{AR}^e$	Repetitive Avalanche Energy	0.12	mJ

Note a : limited by maximum junction temperature.

Note b : Bond wire current limit.

Note c :  $V_{DS}=520\text{V}$ ,  $I_D=6\text{A}$ .

Note d :  $I_D=0.9\text{A}$ ,  $V_{DD}=50\text{V}$ ,  $T_j=25^\circ\text{C}$ .

Note e : Repetitive Rating : Pulse width limited by maximum junction temperature.

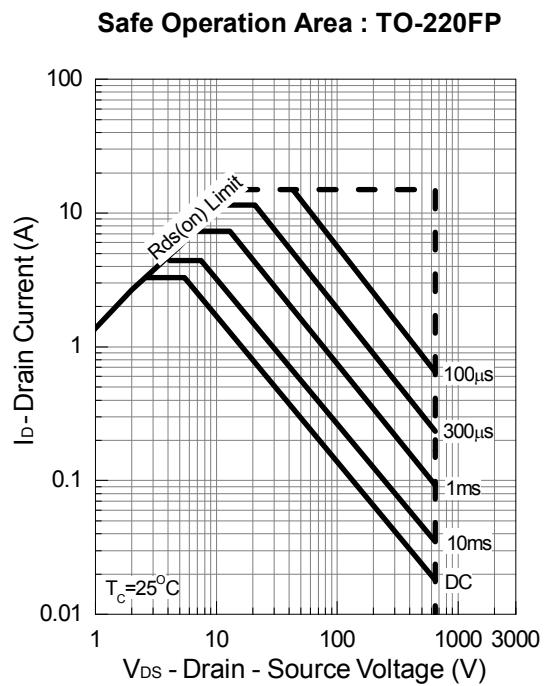
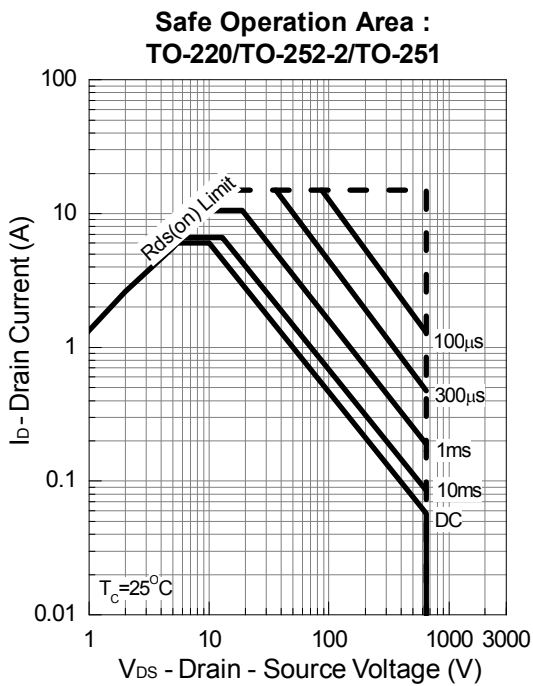
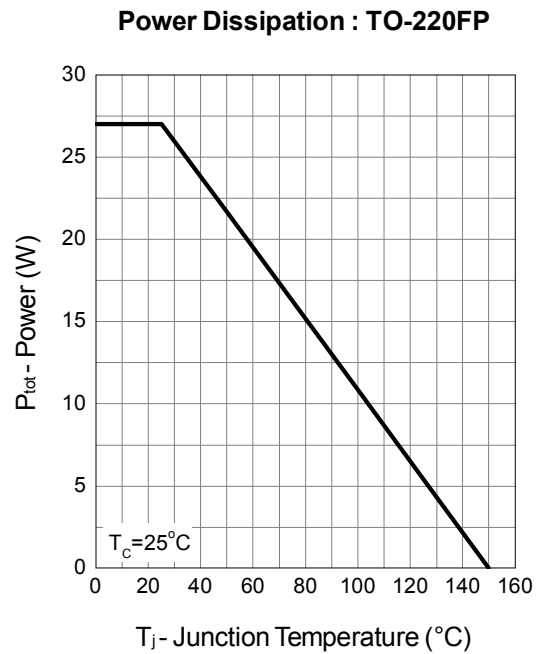
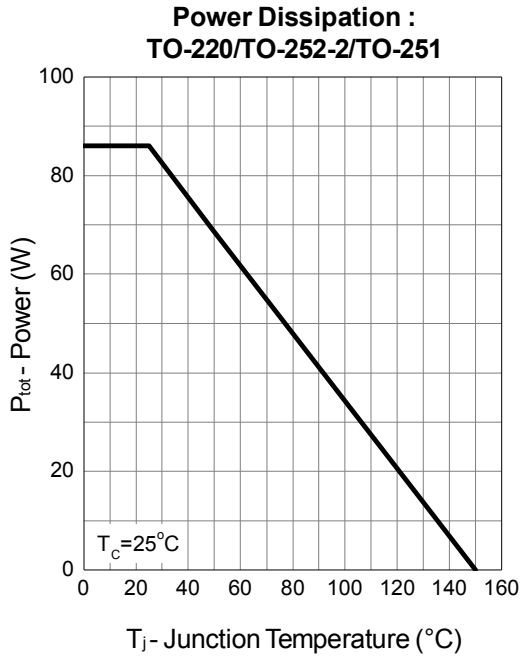
**Electrical Characteristics** ( $T_A = 25^\circ\text{C}$  Unless Otherwise Noted)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Unit
<b>Static Characteristics</b>						
$BV_{DSS}$	Drain-Source Breakdown Voltage	$V_{GS}=0V, I_{DS}=250\mu A$	650	-	-	V
		$T_J=150^\circ\text{C}$	-	750	-	
$I_{DSS}$	Zero Gate Voltage Drain Current	$V_{DS}=520V, V_{GS}=0V$	-	-	1	$\mu A$
		$T_J=150^\circ\text{C}$	-	-	200	
$V_{GS(th)}$	Gate Threshold Voltage	$V_{DS}=V_{GS}, I_{DS}=250\mu A$	2.5	3.5	4.5	V
$I_{GSS}$	Gate Leakage Current	$V_{GS}=\pm 30V, V_{DS}=0V$	-	-	$\pm 100$	nA
$R_{DS(ON)}^f$	Drain-Source On-state Resistance	$V_{GS}=10V, I_{DS}=2A$	-	0.77	0.89	$\Omega$
<b>Diode Characteristics</b>						
$V_{SD}^f$	Diode Forward Voltage	$I_{SD}=6A, V_{GS}=0V$	-	0.95	1.3	V
$t_{rr}$	Reverse Recovery Time	$I_{SD}=6A, V_R=390V$ $di_{SD}/dt=100A/\mu s$	-	190	-	ns
$Q_{rr}$	Reverse Recovery Charge		-	1.6	-	$\mu C$
$I_{rm}$	Peak Reverse Recovery Current		-	14.5	-	A
<b>Dynamic Characteristics<sup>g</sup></b>						
$R_G$	Gate Resistance	$V_{GS}=0V, V_{DS}=0V,$ $F=1\text{MHz}$	-	2.7	-	$\Omega$
$C_{iss}$	Input Capacitance	$V_{GS}=0V,$ $V_{DS}=25V,$ Frequency=1.0MHz	-	365	475	pF
$C_{oss}$	Output Capacitance		-	370	-	
$C_{rss}$	Reverse Transfer Capacitance		-	7	-	
$t_{d(ON)}$	Turn-on Delay Time	$V_{DD}=400V,$ $I_{DS}=6A, V_{GEN}=10V,$ $R_G=6\Omega$	-	9.5	-	ns
$T_r$	Turn-on Rise Time		-	5.5	-	
$t_{d(OFF)}$	Turn-off Delay Time		-	14	-	
$T_f$	Turn-off Fall Time		-	3.5	-	
<b>Gate Charge Characteristics<sup>g</sup></b>						
$Q_g$	Total Gate Charge	$V_{DS}=520V, V_{GS}=10V,$ $I_{DS}=2A$	-	14	18.2	nC
$Q_{gs}$	Gate-Source Charge		-	3.3	-	
$Q_{gd}$	Gate-Drain Charge		-	6.5	-	

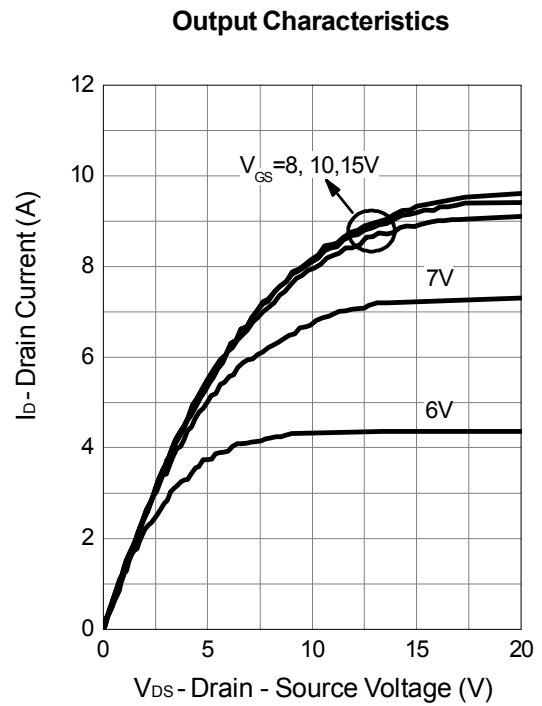
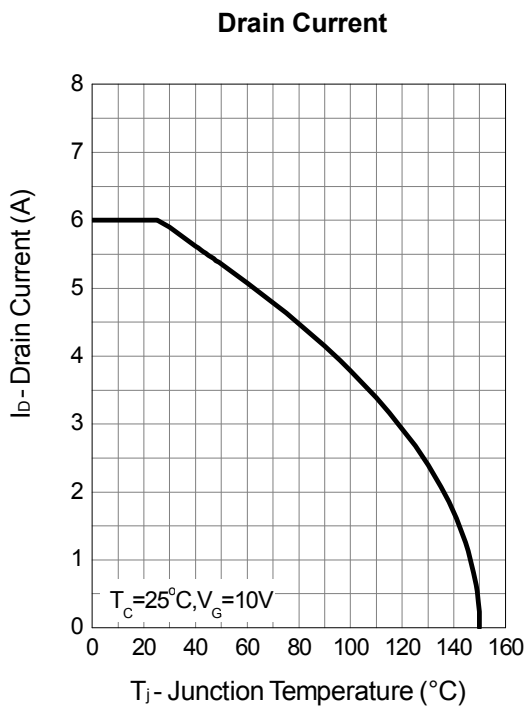
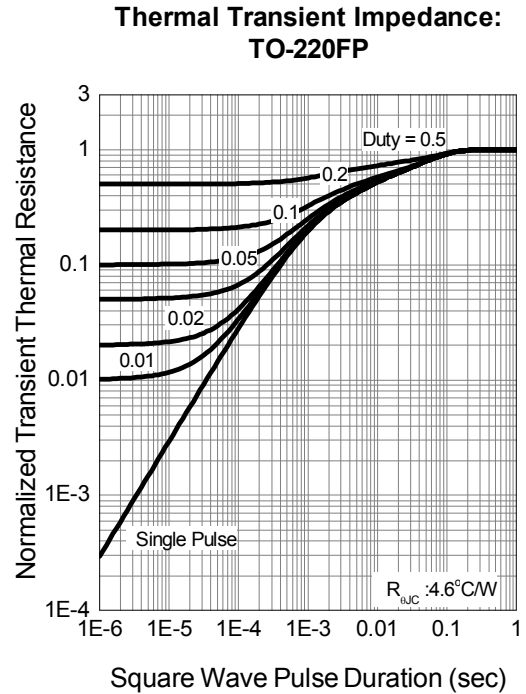
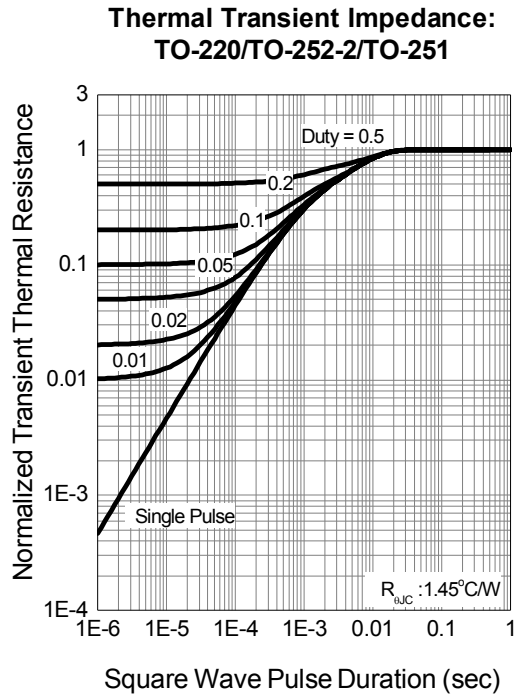
Note f : Pulse test ; pulse width $\leq 300\mu s$ , duty cycle $\leq 2\%$ .

Note g : Guaranteed by design, not subject to production testing.

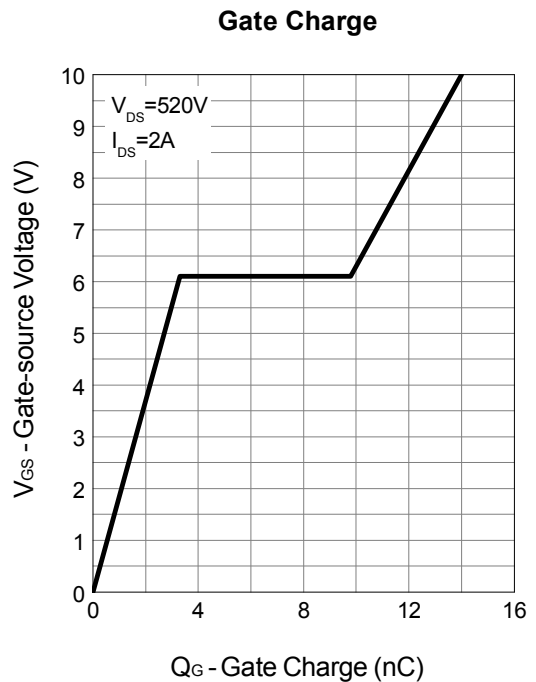
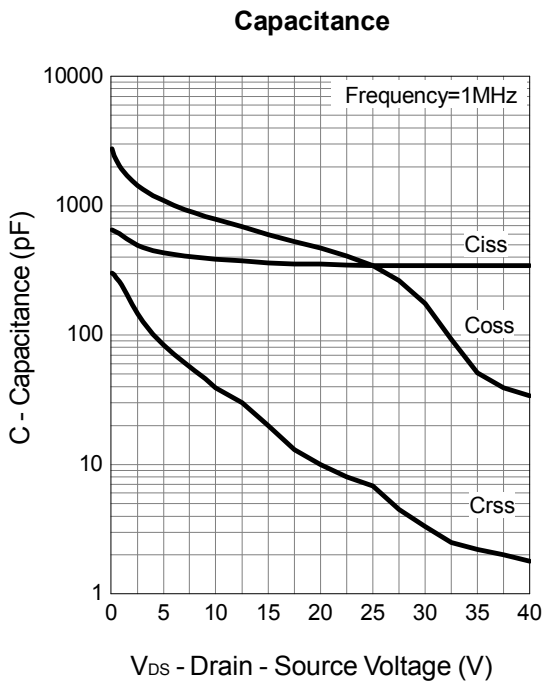
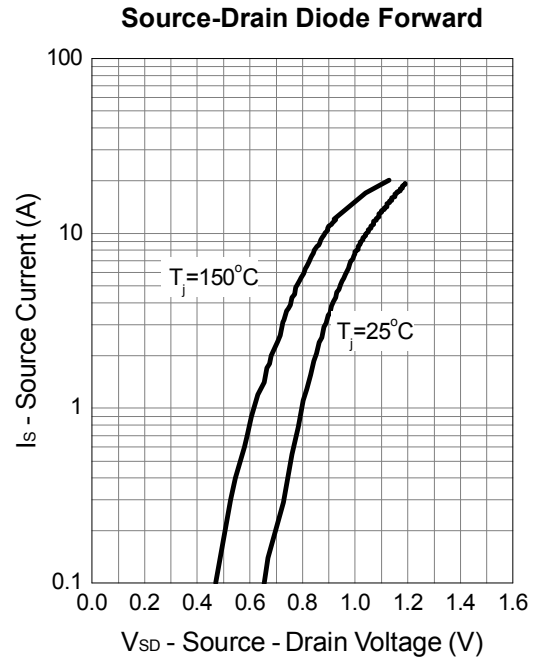
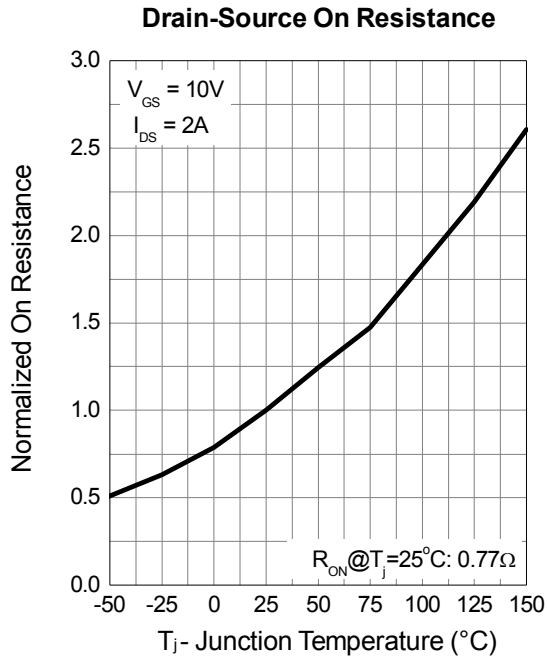
**Typical Operating Characteristics**



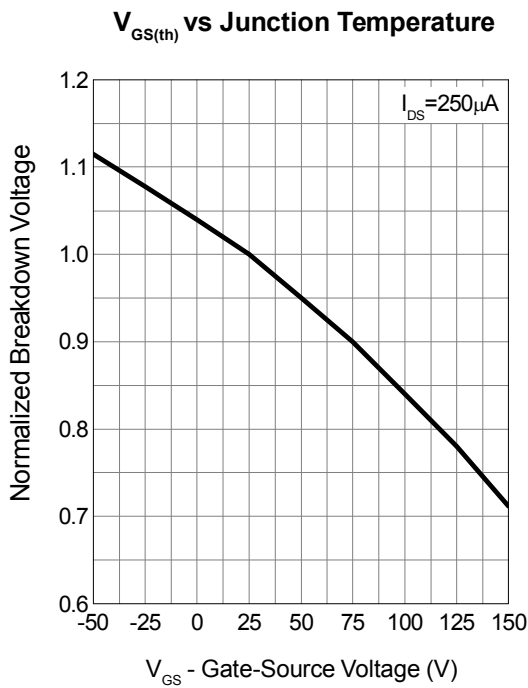
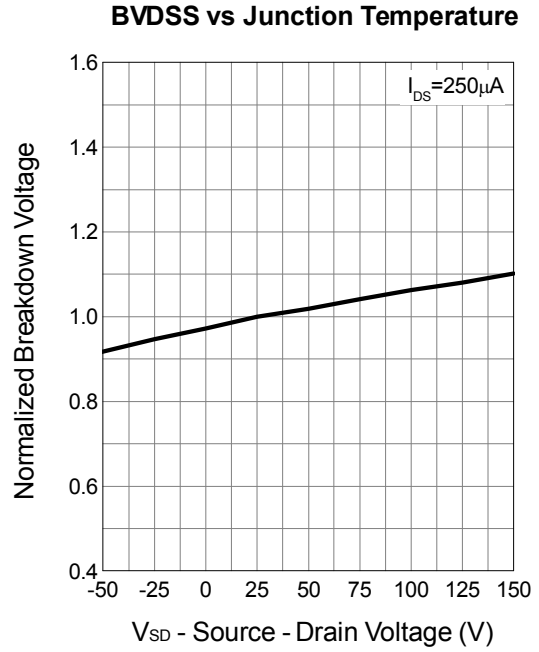
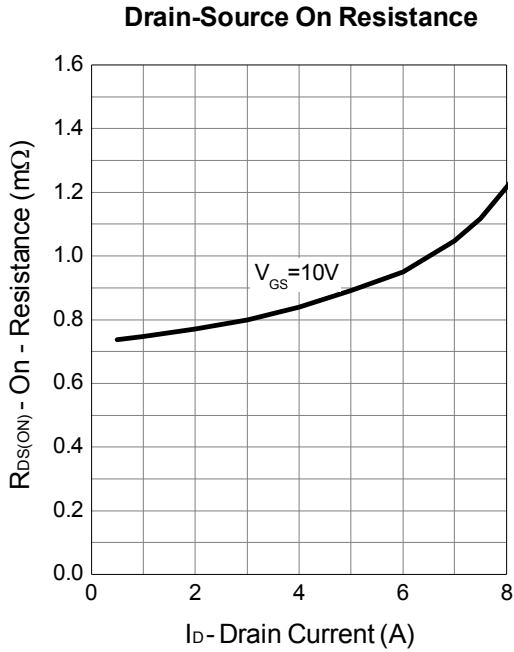
### Typical Operating Characteristics (Cont.)



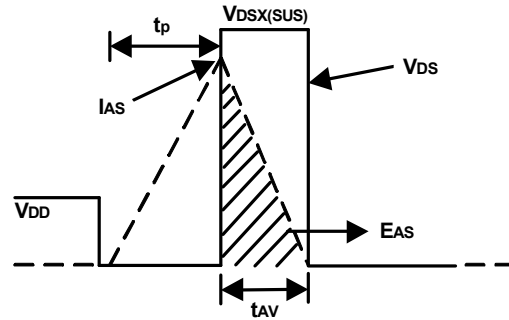
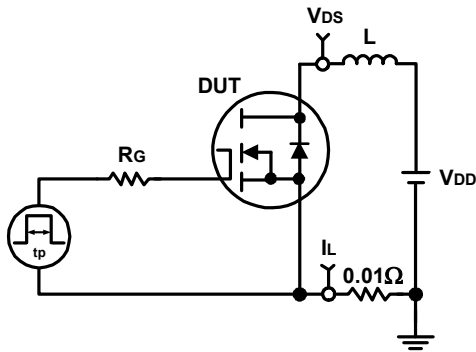
**Typical Operating Characteristics (Cont.)**



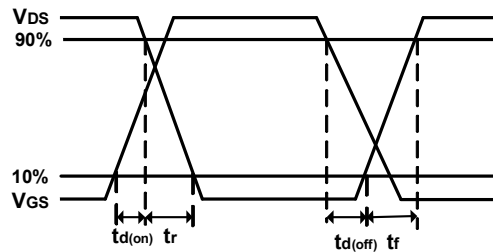
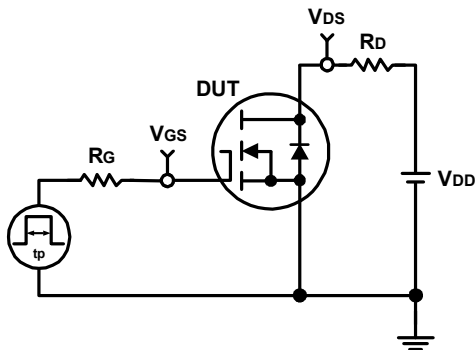
**Typical Operating Characteristics (Cont.)**



## Avalanche Test Circuit and Waveforms



## Switching Time Test Circuit and Waveforms





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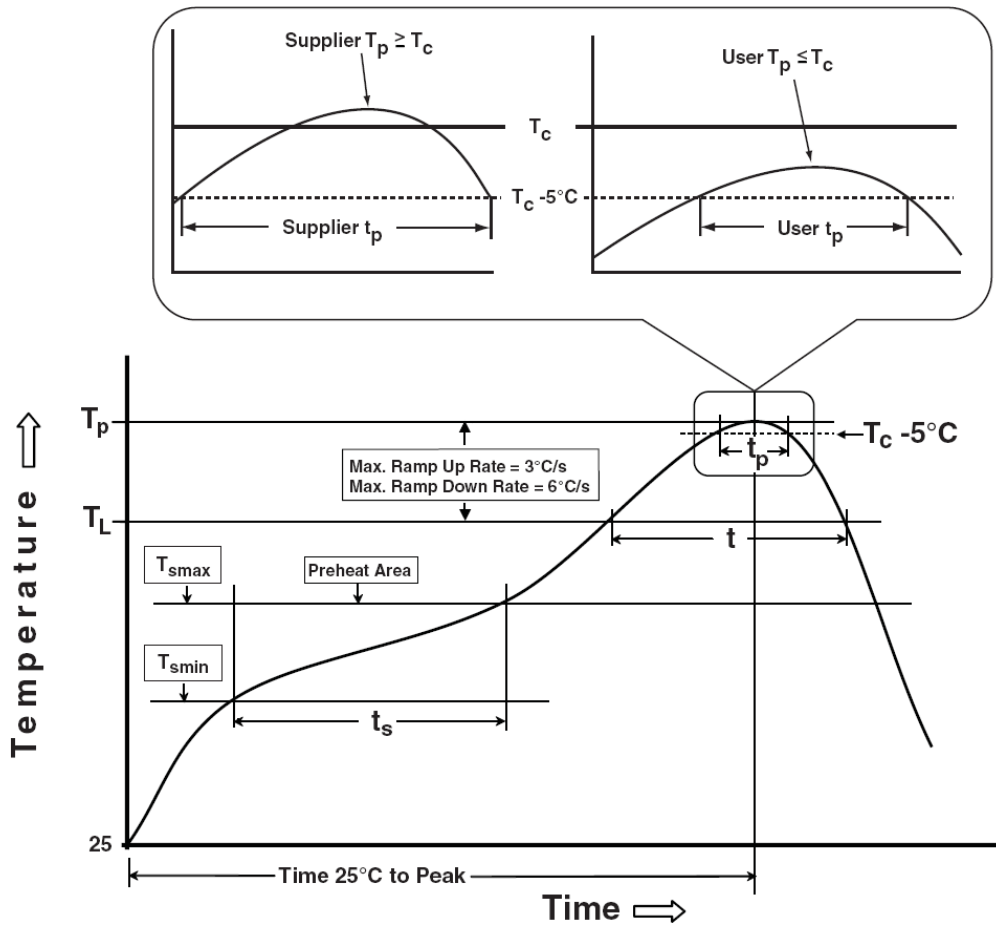
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**Classification Profile**



## Classification Reflow Profiles

Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
<b>Preheat &amp; Soak</b>		
Temperature min ( $T_{smin}$ )	100 °C	150 °C
Temperature max ( $T_{smax}$ )	150 °C	200 °C
Time ( $T_{smin}$ to $T_{smax}$ ) ( $t_s$ )	60-120 seconds	60-120 seconds
Average ramp-up rate ( $T_{smax}$ to $T_p$ )	3 °C/second max.	3°C/second max.
Liquidous temperature ( $T_L$ )	183 °C	217 °C
Time at liquidous ( $t_L$ )	60-150 seconds	60-150 seconds
Peak package body Temperature ( $T_p$ )*	See Classification Temp in table 1	See Classification Temp in table 2
Time ( $t_p$ )** within 5°C of the specified classification temperature ( $T_c$ )	20** seconds	30** seconds
Average ramp-down rate ( $T_p$ to $T_{smax}$ )	6 °C/second max.	6 °C/second max.
Time 25°C to peak temperature	6 minutes max.	8 minutes max.
* Tolerance for peak profile Temperature ( $T_p$ ) is defined as a supplier minimum and a user maximum. ** Tolerance for time at peak profile temperature ( $t_p$ ) is defined as a supplier minimum and a user maximum.		

Table 1. SnPb Eutectic Process – Classification Temperatures ( $T_c$ )

Package Thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> ≥350
<2.5 mm	235 °C	220 °C
≥2.5 mm	220 °C	220 °C

Table 2. Pb-free Process – Classification Temperatures ( $T_c$ )

Package Thickness	Volume mm <sup>3</sup> <350	Volume mm <sup>3</sup> 350-2000	Volume mm <sup>3</sup> >2000
<1.6 mm	260 °C	260 °C	260 °C
1.6 mm – 2.5 mm	260 °C	250 °C	245 °C
≥2.5 mm	250 °C	245 °C	245 °C

## Reliability Test Program

Test item	Method	Description
SOLDERABILITY	JESD-22, B102	5 Sec, 245°C
HTRB	JESD-22, A108	1000 Hrs, 80% of VDS max @ $T_{jmax}$
HTGB	JESD-22, A108	1000 Hrs, 100% of VGS max @ $T_{jmax}$
PCT	JESD-22, A102	168 Hrs, 100%RH, 2atm, 121°C
TCT	JESD-22, A104	500 Cycles, -65°C~150°C

## Customer Service

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